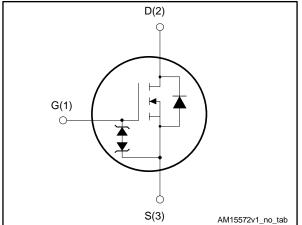
# N-channel 600 V, 0.14 Ω typ., 20 A MDmesh<sup>™</sup> M2 Power MOSFETs in TO-220FP and I<sup>2</sup>PAKFP packages

Datasheet - production data

# TO-220FP I

life.augmented

### Figure 1: Internal schematic diagram



This is information on a product in full production.

### Features

Order code	V <sub>DS</sub> @ T <sub>Jmax</sub>	R <sub>DS(on)</sub> max.	ID	Ртот
STF26N60M2	650 V	0.165 Ω	20 A	30
STFI26N60M2	000 V	0.105 12	20 A	W

- Extremely low gate charge
- Excellent output capacitance (C<sub>OSS</sub>) profile
- 100% avalanche tested
- Zener-protected

### **Applications**

- Switching applications
- LCC converters, resonant converters

### Description

These devices are N-channel Power MOSFETs developed using MDmesh<sup>™</sup> M2 technology. Thanks to their strip layout and improved vertical structure, these devices exhibit low on-resistance and optimized switching characteristics, rendering them suitable for the most demanding high efficiency converters.

### Table 1: Device summary

Order code	Marking	Package	Packing
STF26N60M2		TO-220FP	Tuba
STFI26N60M2	26N60M2	I²PAKFP	Tube

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### Contents

# Contents

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		TO-220FP package information I <sup>2</sup> PAKFP (TO-281) package information	



# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>GS</sub>	Gate-source voltage	±25	V
ار <sup>(1)</sup>	Drain current (continuous) at T <sub>case</sub> = 25 °C	20	А
ID	Drain current (continuous) at T <sub>case</sub> = 100 °C	13	A
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	80	А
P <sub>TOT</sub>	Total dissipation at $T_{case} = 25 \text{ °C}$	30	W
dv/dt <sup>(3)</sup>	Peak diode recovery voltage slope	15	V/ns
dv/dt <sup>(4)</sup>	MOSFET dv/dt ruggedness	50	V/IIS
V <sub>ISO</sub>	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; $T_C = 25$ °C)	2.5	kV
T <sub>stg</sub>	Storage temperature	55 to 150	°C
Tj	Operating junction temperature	-55 to 150	

### Notes:

<sup>(1)</sup> Limited by maximum junction temperature.

 $^{\left( 2\right) }$  Pulse width is limited by safe operating area.

 $^{(3)}$  I\_{SD}  $\leq 20$  A, di/dt=400 A/µs; V\_{DS(peak)} < V\_{(BR)DSS}, V\_DD = 80% V\_(BR)DSS.

<sup>(4)</sup>  $V_{DS} \le 480 \text{ V}.$ 

### Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	4.2	
R <sub>thj-amb</sub>	Thermal resistance junction-ambient	62.5	°C/W

### **Table 4: Avalanche characteristics**

Symbol	Parameter	Value	Unit
I <sub>AR</sub> <sup>(1)</sup>	Avalanche current, repetitive or not repetitive	3.8	А
E <sub>AR</sub> <sup>(2)</sup>	Single pulse avalanche energy	250	mJ

### Notes:

 $^{\left( 1\right) }$  Pulse width limited by  $T_{jmax}.$ 

 $^{(2)}$  starting  $T_{j}$  = 25 °C,  $I_{D}$  =  $I_{AR},\,V_{DD}$  = 50 V.



# 2 Electrical characteristics

 $(T_{case} = 25 \text{ °C unless otherwise specified})$ 

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS}$ = 0 V, $I_D$ = 1 mA	600			V
	Zara gata valtaga drain	$V_{GS} = 0 V, V_{DS} = 600 V$			1	
I <sub>DSS</sub>	Zero gate voltage drain current	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 600 V, T <sub>case</sub> = 125 °C			100	μA
I <sub>GSS</sub>	Gate-body leakage current	$V_{DS} = 0 V, V_{GS} = \pm 25 V$			±10	μA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS}$ = $V_{GS}$ , $I_D$ = 250 $\mu$ A	2	3	4	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$		0.14	0.165	Ω

Table 6: Dynamic						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	1360	-	
Coss	Output capacitance	V <sub>DS</sub> = 100 V, f = 1 MHz,	-	88	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	$V_{GS} = 0 V$	-	2	-	P
C <sub>oss eq.</sub> <sup>(1)</sup>	Equivalent output capacitance	$V_{\text{DS}}$ = 0 to 480 V, $V_{\text{GS}}$ = 0 V	-	124	-	pF
$R_{G}$	Intrinsic gate resistance	$f = 1 MHz$ , $I_D = 0 A$	-	4	-	Ω
Qg	Total gate charge	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 20 A,	-	34	-	
Q <sub>gs</sub>	Gate-source charge	$V_{GS} = 10 \text{ V}$ (see <i>Figure 15:</i>	-	5.6	-	nC
$Q_{gd}$	Gate-drain charge	"Gate charge test circuit")	-	16.3	-	

### Notes:

 $^{(1)}$   $C_{oss\ eq.}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ .

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	20.2	-	
tr	Rise time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$ (see Figure 14: "Switching times	-	8	-	
t <sub>d(off)</sub>	Turn-off delay time	test circuit for resistive load"	-	66	-	ns
t <sub>f</sub>	Fall time	and Figure 19: "Switching time waveform")	-	10	-	



### Electrical characteristics

	Table 8: Source-drain diode							
Symbol	Symbol Parameter Test conditions		Min.	Тур.	Max.	Unit		
I <sub>SD</sub>	Source-drain current		-		20	А		
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		80	А		
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	$V_{GS} = 0 V, I_{SD} = 20 A$	-		1.6	V		
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 20 A, di/dt = 100 A/µs,	-	360		ns		
Qrr	Reverse recovery charge	V <sub>DD</sub> = 60 V (see <i>Figure 16:</i> "Test circuit for inductive load	-	5		μC		
I <sub>RRM</sub>	Reverse recovery current	switching and diode recovery times")	-	27		А		
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 20 A, di/dt = 100 A/µs,	-	556		ns		
Q <sub>rr</sub>	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 \text{ °C}$ (see Figure 16: "Test circuit for	-	8		μC		
I <sub>RRM</sub>	Reverse recovery current	inductive load switching and diode recovery times")	-	29		А		

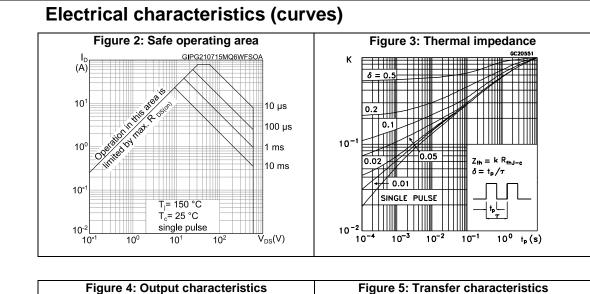
### Notes:

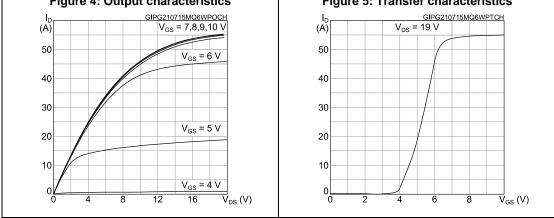
 $^{\left(1\right)}$  Pulse width is limited by safe operating area.

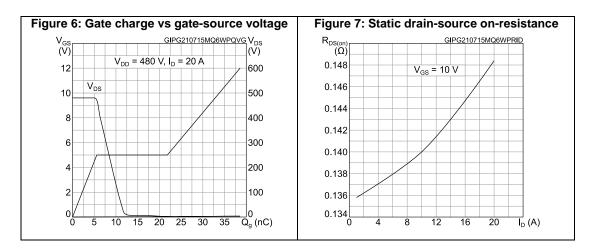
 $^{(2)}$  Pulse test: pulse duration = 300  $\mu s,$  duty cycle 1.5%.



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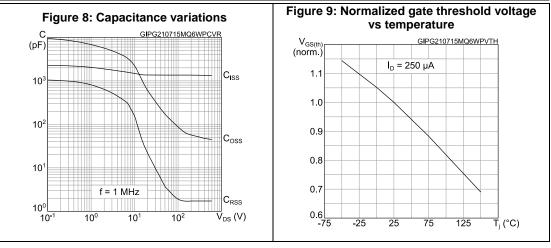


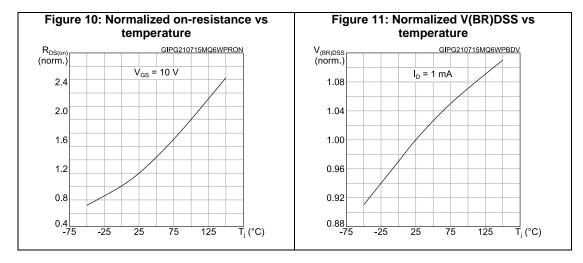
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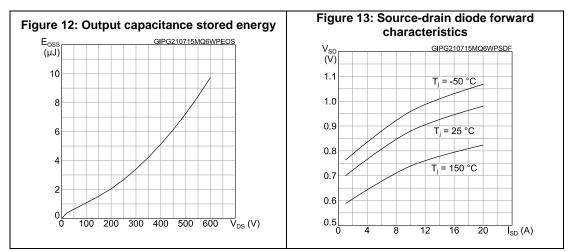
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### **Electrical characteristics**



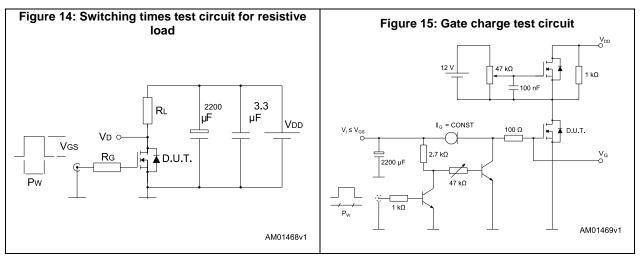


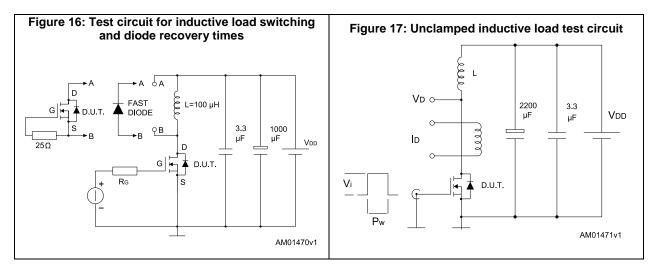


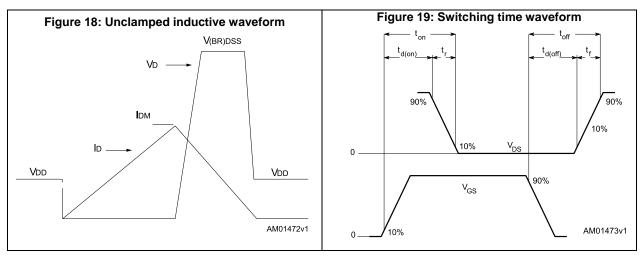
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# 3 Test circuits







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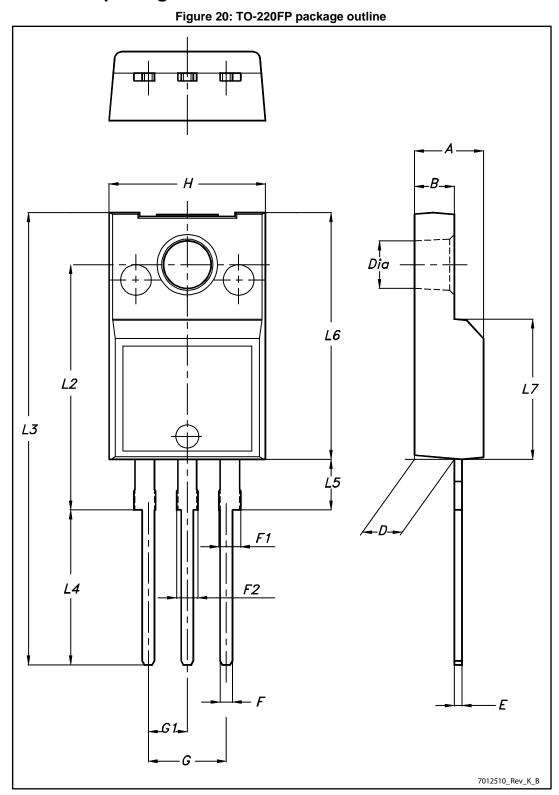
# 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.



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# 4.1 TO-220FP package information



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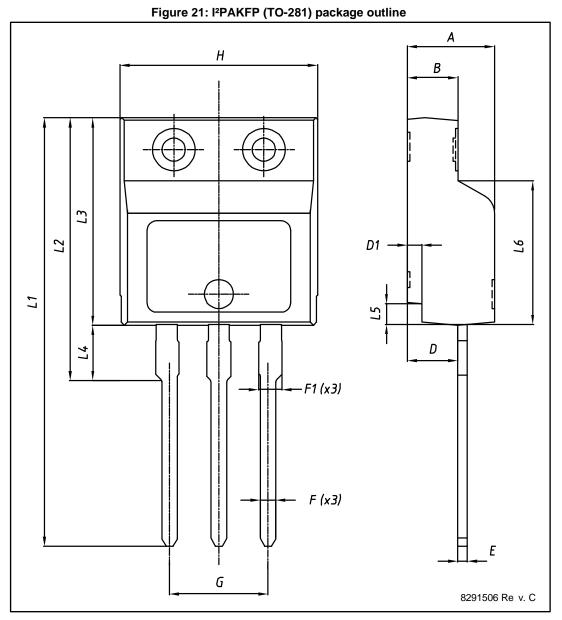
### Package information

Table 9: TO-220FP package mechanical data					
Dim.		mm			
Dini.	Min.	Тур.	Max.		
A	4.4		4.6		
В	2.5		2.7		
D	2.5		2.75		
E	0.45		0.7		
F	0.75		1		
F1	1.15		1.70		
F2	1.15		1.70		
G	4.95		5.2		
G1	2.4		2.7		
Н	10		10.4		
L2		16			
L3	28.6		30.6		
L4	9.8		10.6		
L5	2.9		3.6		
L6	15.9		16.4		
L7	9		9.3		
Dia	3		3.2		



Package information

# 4.2 I<sup>2</sup>PAKFP (TO-281) package information



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### Package information

Table 10: I <sup>2</sup> PAKFP (TO-281) mechanical data				
Dim.	mm			
	Min.	Тур.	Max.	
A	4.40	-	4.60	
В	2.50		2.70	
D	2.50		2.75	
D1	0.65		0.85	
E	0.45		0.70	
F	0.75		1.00	
F1			1.20	
G	4.95		5.20	
Н	10.00		10.40	
L1	21.00		23.00	
L2	13.20		14.10	
L3	10.55		10.85	
L4	2.70		3.20	
L5	0.85		1.25	
L6	7.50	7.60	7.70	



# 5 Revision history

Table 11: Document revision history

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Date	Revision	Changes
05-Mar-2015	1	First release.
30-July-2015	2	Text and formatting changes throughout document Datasheet promoted from preliminary data to production data In Section <i>Electrical characteristics</i> : - updated and renamed table <i>Static</i> (was On/off states) - updated table <i>Dynamic</i> , <i>Switching times</i> and <i>Source-drain diode</i> - added section <i>Electrical characteristics (curves)</i>



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